MA4X713 (MA713)

Silicon epitaxial planar type

For switching

For wave detection

Features

- Two isolated elements are contained in one package, allowing high-density mounting
- Two MA3X704A (MA704A) is contained in one package (of a type in the same direction)
- Low forward voltage V_F , optimum for low voltage rectification
- Optimum for high frequency rectification because of its short reverse recovery time (t_{rr})
- Mini type 4-pin package

■ Absolute Maximum Ratings $T_a = 25$ °C

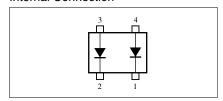
Parameter		Symbol	Rating	Unit
Reverse voltage (DC)		V_R	30	V
Peak forward	Single	I_{FM}	150	mA
current	Double *		110	
Forward current (DC)	Single	I_F	30	mA
	Double *		20	
Junction temperature		T _j	125	°C
Storage temperature		T_{stg}	-55 to +125	°C

Note) *: Value per chip

2.90^{+0.02} Unit: mm 2.90^{+0.02} 0.16^{+0.1} 1.9±0.2 (0.95) (0.95) (0.95) 0.5R 200 200 0.60^{+0.10} 1.1 Cathode 1 2: Cathode 2 3: Anode 2 4: Anode 1 EIAJ: SC-61 Mini4-G1 Package

Marking Symbol: M1N

Internal Connection

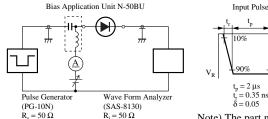


■ Electrical Characteristics $T_a = 25$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current (DC)	I_R	$V_R = 30 \text{ V}$			1	μΑ
Forward voltage (DC)	V _{F1}	$I_F = 1 \text{ mA}$			0.4	V
	V _{F2}	$I_F = 30 \text{ mA}$			1.0	
Terminal capacitance	C _t	$V_R = 1 \text{ V, f} = 1 \text{ MHz}$		1.5		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 10 \text{ mA}$		1.0		ns
		$I_{rr} = 1 \text{ mA}, R_L = 100 \Omega$				
Detection efficiency	η	$V_{in} = 3 V_{(peak)}$, $f = 30 MHz$		65		%
		$R_L = 3.9 \text{ k}\Omega, C_L = 10 \text{ pF}$				

Note) 1. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

2. Rated input/output frequency: 200 MHz 3. *: t_{rr} measuring instrument



Note) The part number in the parenthesis shows conventional part number.

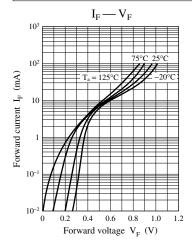
Output Pulse

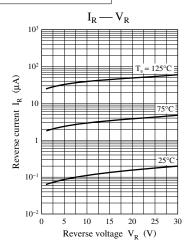
 $I_{R} = 10 \text{ mA}$

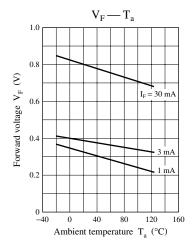
 $R_L = 100 \Omega$

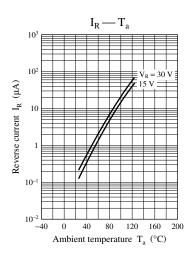
MA4X713 Panasonic

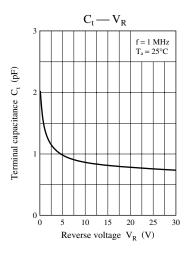
Characteristics charts between pins 1 and 4, 2 and 3











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